

# Single P-channel MOSFET

## ELM17405GA-S

### ■ General description

ELM17405GA-S uses advanced trench technology to provide excellent  $R_{ds(on)}$ , low gate charge and operation with gate voltages as low as 2.5V.

### ■ Features

- $V_{ds} = -30V$
- $I_d = -1.6A$  ( $V_{gs} = -10V$ )
- $R_{ds(on)} < 150m\Omega$  ( $V_{gs} = -10V$ )
- $R_{ds(on)} < 200m\Omega$  ( $V_{gs} = -4.5V$ )
- $R_{ds(on)} < 280m\Omega$  ( $V_{gs} = -2.5V$ )

### ■ Maximum absolute ratings

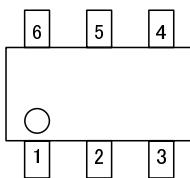
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	$V_{ds}$	-30	V	
Gate-source voltage	$V_{gs}$	$\pm 12$	V	
Continuous drain current Ta=25°C	$I_d$	-1.6	A	1
Ta=70°C		-1.3		
Pulsed drain current	$I_{dm}$	-10	A	2
Power dissipation Ta=25°C	$P_d$	0.625	W	1
Ta=70°C		0.400		
Junction and storage temperature range	$T_j, T_{stg}$	-55 to 150	°C	

### ■ Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	t≤10s	$R_{\theta ja}$	160	200	°C/W	1
Maximum junction-to-ambient	Steady-state		180	220	°C/W	
Maximum junction-to-lead	Steady-state	$R_{\theta jl}$	130	160	°C/W	3

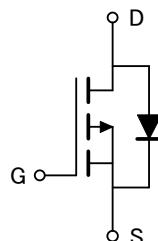
### ■ Pin configuration

SC-70-6 (TOP VIEW)



Pin No.	Pin name
1	DRAIN
2	DRAIN
3	GATE
4	SOURCE
5	DRAIN
6	DRAIN

### ■ Circuit



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### ■ Electrical characteristics

$T_a=25^\circ C$

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
<b>STATIC PARAMETERS</b>						
Drain-source breakdown voltage	BVdss	$Id=-250\ \mu A, Vgs=0V$	-30			V
Zero gate voltage drain current	Idss	Vds=-24V			-1	$\mu A$
		Vgs=0V	Tj=55°C		-5	
Gate-body leakage current	Igss	Vds=0V, Vgs=±12V			±100	nA
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=-250 $\mu A$	-0.6	-1.0	-1.4	V
On state drain current	Id(on)	Vgs=-4.5V, Vds=-5V	-10			A
Static drain-source on-resistance	Rds(on)	Vgs=-10V		115	150	$m\Omega$
		Id=-1.6A	Tj=125°C	195	240	
		Vgs=-4.5V, Id=-1A		135	200	$m\Omega$
		Vgs=-2.5V, Id=-1A		190	280	$m\Omega$
Forward transconductance	Gfs	Vds=-5V, Id=-1.6A	3	4		S
Diode forward voltage	Vsd	Is=-1A, Vgs=0V		-0.85	-1.00	V
Max. body-diode continuous current	Is				-0.5	A
<b>DYNAMIC PARAMETERS</b>						
Input capacitance	Ciss	Vgs=0V, Vds=-15V, f=1MHz		409		pF
Output capacitance	Coss			55		pF
Reverse transfer capacitance	Crss			42		pF
Gate resistance	Rg	Vgs=0V, Vds=0V, f=1MHz		12		$\Omega$
<b>SWITCHING PARAMETERS</b>						
Total gate charge	Qg	Vgs=-4.5V, Vds=-15V Id=-1A		5.06		nC
Gate-source charge	Qgs			0.72		nC
Gate-drain charge	Qgd			1.58		nC
Turn-on delay time	td(on)	Vgs=-10V, Vds=-15V Rl=15 $\Omega$ , Rgen=3 $\Omega$		6.2		ns
Turn-on rise time	tr			3.2		ns
Turn-off delay time	td(off)			41.2		ns
Turn-off fall time	tf			14.5		ns
Body diode reverse recovery time	trr	If=-1A, dl/dt=100A/ $\mu s$		13.2		ns
Body diode reverse recovery charge	Qrr	If=-1A, dl/dt=100A/ $\mu s$		5.4		nC

### NOTE :

1. The value of  $R_{\theta ja}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board of 2oz. Copper, in still air environment with  $T_a=25^\circ C$ . The value in any given applications depends on the user's specific board design, The current rating is based on the  $t \leq 10s$  thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The  $R_{\theta ja}$  is the sum of the thermal impedance from junction to lead  $R_{\theta jl}$  and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80  $\mu s$  pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_a=25^\circ C$ . The SOA curve provides a single pulse rating.

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## ■ Typical electrical and thermal characteristics

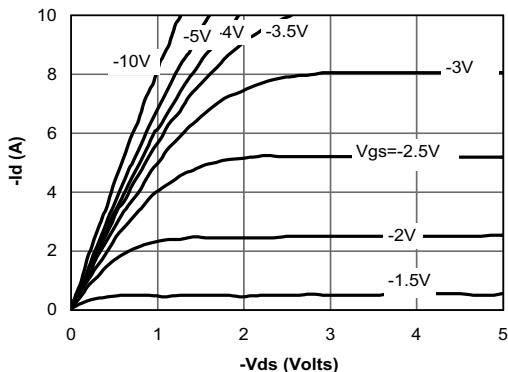


Fig 1: On-Region Characteristics

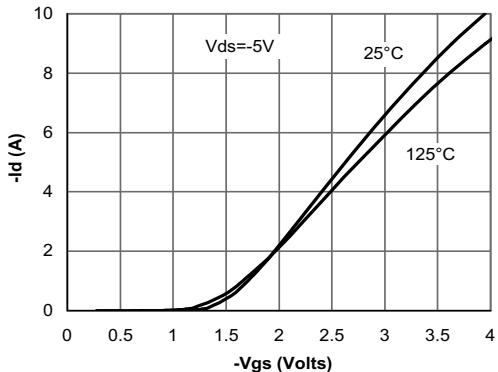


Figure 2: Transfer Characteristics

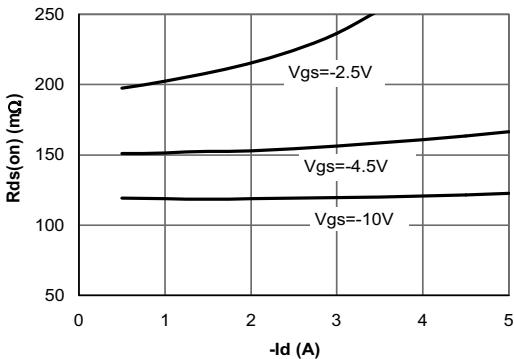


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

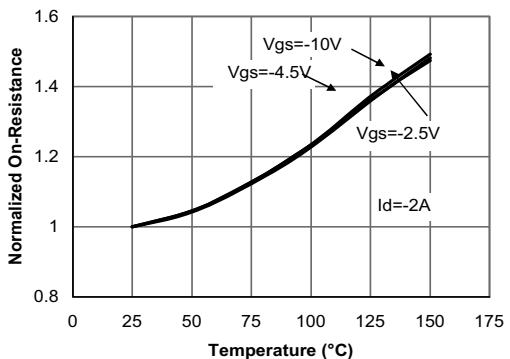


Figure 4: On-Resistance vs. Junction Temperature

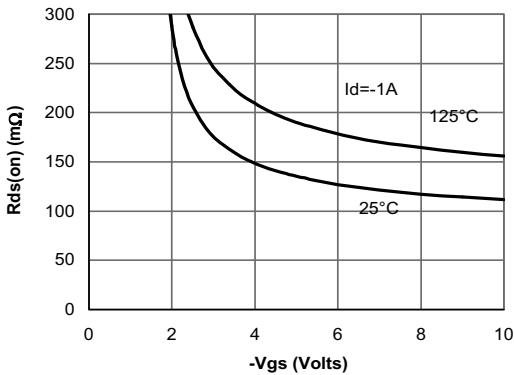


Figure 5: On-Resistance vs. Gate-Source Voltage

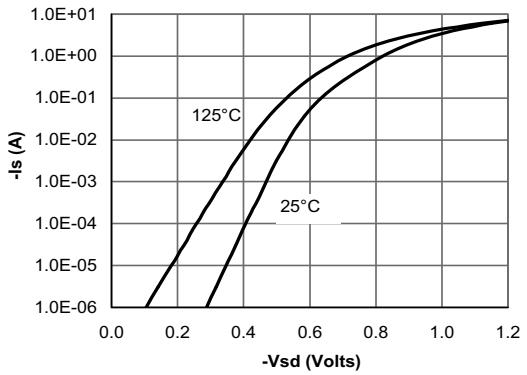


Figure 6: Body-Diode Characteristics

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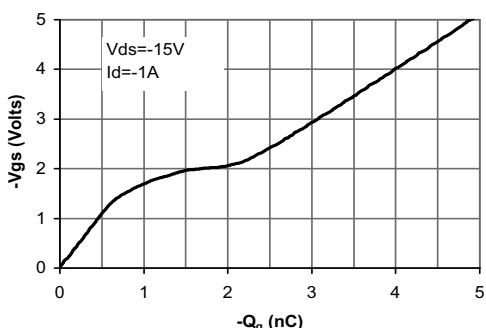


Figure 7: Gate-Charge Characteristics

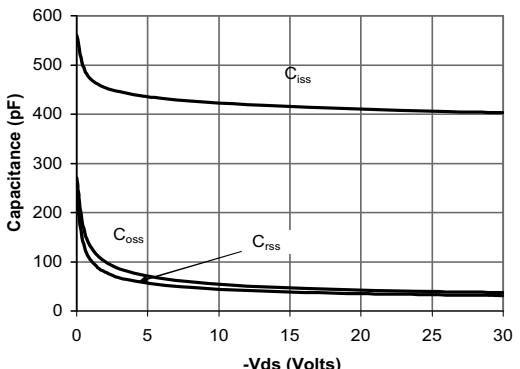


Figure 8: Capacitance Characteristics

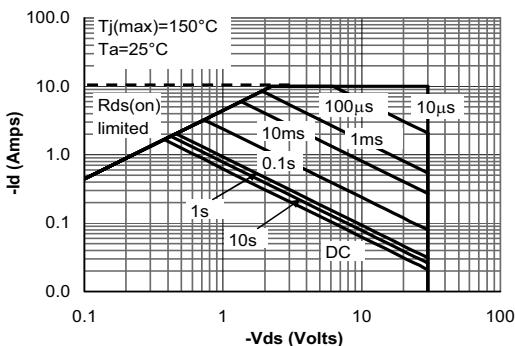


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

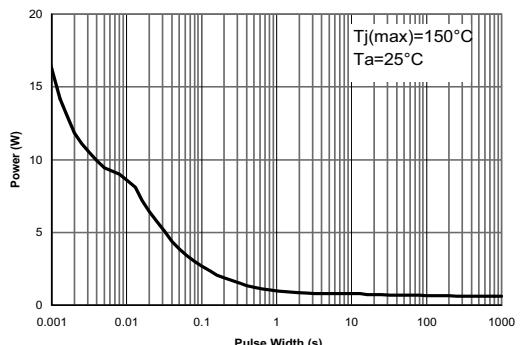


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

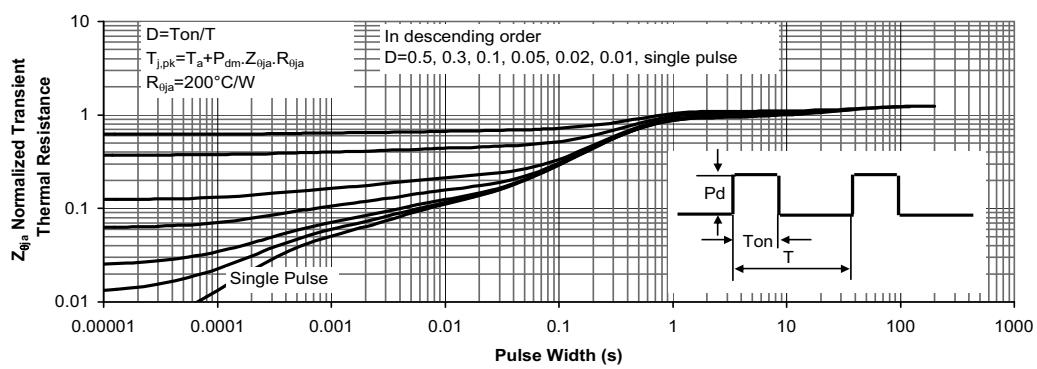


Figure 11: Normalized Maximum Transient Thermal Impedance